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Inventor Information for 10/658261

Inventor Name	City	State/Country
COHEN, ADAM L.	ARLINGTON	MASSACHUSETTS
GOLDEN, JOHN B.	NORTON	MASSACHUSETTS
VU, LIEM T.	NEEDHAM	MASSACHUSETTS

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US 20060112550 A1	US- PGPUB	20060601	Microprobe tips and methods for making	29/884		Kim; Kieun et al.
US 20060109016 A1	US- PGPUB	20060525	Microprobe tips and methods for making	324/754		Arat; Vacit et al.
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US 20050215046 A1	US- PGPUB	20050929	Electrochemical fabrication methods incorporating dielectric materials and/or using dielectric substrates	438/619	438/628; 438/654; 438/669	Cohen, Adam L. et al.
US 20050215023 A1	US- PGPUB	20050929	Electrochemical fabrication process for forming multilayer multimaterial microprobe structures	438/381		Cohen, Adam L. et al.
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US 20050176238 A1	US- PGPUB	20050811	Electrochemical fabrication methods incorporating dielectric materials and/or using dielectric substrates	438/625	205/118; 438/622	Cohen, Adam L. et al.
US 20050173374 A1	US- PGPUB	20050811	Electrochemical fabrication methods incorporating dielectric materials and/or using dielectric substrates	216/41		Cohen, Adam L. et al.
US 20050171402 A1	US- PGPUB	20050804	Endoscope channel cap	600/154		Cohen, Adam L. et al.
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US 20050023145 A1	US- PGPUB	20050203	Methods and apparatus for forming multi-layer structures using adhered masks	205/118	205/135	Cohen, Adam L. et al.
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US 20040251142 A1	US- PGPUB	20041216	Methods of reducing interlayer discontinuities in electrochemically fabricated three-dimensional structures	205/223	205/115	Cohen, Adam L. et al.
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US 20040182716 A1	US- PGPUB	20040923	Method for electrochemically forming structures including non-parallel mating of contact masks and substrates	205/170	205/118	Cohen, Adam L. et al.
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US 20040134788 A1	US- PGPUB	20040715	Multi-cell masks and methods and apparatus for using such masks to form three-dimensional structures	205/135	205/170; 205/223	Cohen, Adam L. et al.
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US 20040065552 A1	US- PGPUB	20040408	Method for electrochemical fabrication	205/118	205/170	Cohen, Adam L.
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US 20040004002 A1	US- PGPUB	20040108	Electrochemically fabricated structures having dielectric or active bases and methods of and apparatus for producing such structures	205/118	205/134	Thompson, Jeffrey A. et al.
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US 20040000489 A1	US- PGPUB	20040101	Methods and apparatus for monitoring deposition quality during conformable contact mask plating operations	205/118	205/122; 257/E21.175; 257/E21.586	Zhang, Gang et al.
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US 20030121791 A1	US- PGPUB	20030703	Methods of and apparatus for making high aspect ratio microelectromechanical structures	205/93	205/135; 205/223; 257/E21.175; 257/E21.589	Cohen, Adam L.
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US 20010014409 A1	US- PGPUB	20010816	Article, method, and apparatus for electrochemical fabrication	428/606	204/280; 205/67; 205/70	Cohen, Adam L.
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